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WHAT IS CLAIMED IS:

- 1. A process for making a refractory metal part comprising:
- (a) loading powder metal particles into a hopper for feeding into a laser additive chamber,
 - (b) loading a substrate into the laser additive chamber,
- (c) feeding the powder metal powders into the additive chamber onto successive points on the substrate in a linear trace,
- (d) melting the substrate and the powder with a laser beam and building up multiple coatings of a controlled microstructure,
- 10 (e) tracing the substrate over a selected area with a combined deposition and melt beam and building up a coating of a controlled microstructure in multipe layers, and
 - (f) building up a deposit from the coating and forming a refractory metal part.
- 15 2. The process of Claim 1, wherein the deposit built up from the coating is a fully dense deposit.
 - 3. The process of Claim 1, wherein the process is carried out under inert conditions.
 - 4. The process of Claim 3, wherein the conditions include argon, at or near or below atmospheric pressure.
 - 5. The process of Claim 1, wherein the process is carried out under a hard vacuum.
 - 6. The process of Claim 1, wherein the laser beam generates sufficiently high heat to create conditions that purify the powder and the refractory metal part.
 - 7. The process of Claim 1, wherein the refractory metal part is a sputtering target.
 - 8. A refractory metal part made by the process of Claim 1.
- 9. A method for rejuvenating a tantalum sputtering target comprising subjecting an eroded region of a tantalum sputtering target

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to plasma deposition, forming a fully dense coating, and thereby rejuvenating the tantalum sputtering target.

- 10. The method of Claim 9, wherein the tantalum sputtering target has a backing plate and the target is rejuvenated without debonding the backing plate from the target.
 - 11. A sputtering target made by the method of Claim 9.
- 10. A method for rejuvenating a tantalum sputtering target comprising subjecting an eroded region of a tantalum sputtering target to laser sintering, forming a fully dense coating, thereby rejuvenating the tantalum sputtering target.
- 11. The method of Claim 10, wherein the tantalum sputtering target has a backing plate and the target is rejuvenated without debonding the backing plate from the target.
 - 12. A sputtering target made by the method of Claim 10.
- 13. A method for rejuvenating a tantalum sputtering target comprising subjecting an eroded region of a sputtering target to hot isostatic pressing, forming a fully dense coating, and filling the eroded region of a tantalum sputtering target, thereby rejuvenating the tantalum sputtering target.
- 20 14. A sputtering target made by the method of Claim 13.